

01/982,966

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
1	BRS	L1	10701	((PCB or board or substrate) near (hole or opening or via)) and (trace or conductor)) and (terminal or contact)	USPA T; US-P GPUB ; EPO; JPO; DER WEN T; IBM_T DB	2003/11/08 09:20	
2	BRS	L2	5837	1 and (fit\$3 or insert\$3)	USPA T; US-P GPUB ; EPO; JPO; DER WEN T; IBM_T DB	2003/11/08 09:20	
3	BRS	L3	5891	1 and (fit\$4 or insert\$3)	USPA T; US-P GPUB ; EPO; JPO; DER WEN T; IBM_T DB	2003/11/08 09:20	
4	BRS	L4	1399	3 and (fit\$4 or insert\$3) near (hole or opening or via)	USPA T; US-P GPUB ; EPO; JPO; DER WEN T; IBM_T DB	2003/11/08 09:21	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
5	BRS	L5	1064	4 and plurality	USPA T; US-P GPUB ; EPO; JPO; DER WEN T; IBM_T DB	2003/11/08 09:21	
6	BRS	L6	455	5 and 439/\$.ccls.	USPA T; US-P GPUB ; EPO; JPO; DER WEN T; IBM_T DB	2003/11/08 09:22	
7	BRS	L7	178	5 and 361/\$.ccls.	USPA T; US-P GPUB ; EPO; JPO; DER WEN T; IBM_T DB	2003/11/08 09:22	
8	BRS	L8	121	5 and 174/\$.ccls.	USPA T; US-P GPUB ; EPO; JPO; DER WEN T; IBM_T DB	2003/11/08 09:22	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
9	BRS	L9	612	6 or 7 or 8	USPA T; US-P GPUB ; EPO JPO; DER WEN T; IBM_T DB	2003/11/08 09:23	
10	BRS	L10	376	9 and terminals	USPA T; US-P GPUB ; EPO JPO; DER WEN T; IBM_T DB	2003/11/08 09:23	